DISCONTINUATION NOTICE TB62705CPG,TB62705CFNG SERIES

THE FOLLOWING HAVE BEEN DISCONTINUED AS OF MAR 2009:

TB62705CPG
TB62705CFG
TB62705CFGEL
TB62705CFNG
TB62705CFNGEL

STOCK IS LIMITED ON ABOVE PLEASE SEE SUGGESTED REPLACEMENT DRIVERS: TB62777FNGEL TB62778FNGEL

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ENGINEERING OR SALES
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TOSHIBA BI-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

TB62705CPG, TB62705CFG, TB62705CFNG

8-BIT SHIFT REGISTER, LATCHES & CONSTANT-CURRENT DRIVERS

The TB62705CPG / CFG / CFNG are specifically designed for LED and LED DISPLAY constant-current drivers.

These constant-current output circuits $\,$ can support the set-up of an external resistor (I_{OUT} = $5 \sim 90 \,\text{mA}$).

This I_C is a monolithic integrated circuit designed to be used together with Bi-CMOS process.

The devices consist of an 8-bit shift register, latch, AND-GATE and constant-current drivers.

This devices are a product for the Pb free(Sn-Ag).

FEATURES

• Constant-current Output : current with one resistor for

5 to 90mA.

• Maximum Clock Frequency : fclk = 15 (MHz)

(Cascade Connecte Operate,

Topr = 25°C)

• 5V C-MOS Compatible Input

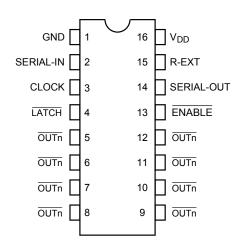
• Package : DIP16-P-300-2.54A (TB62705CPG)

SSOP16-P-225-1.00A (TB62705CFG) SSOP16-P-225-0.65B (TB62705CFNG)

• Constant Output Current Matching:

OUTPUT-GND VOLTAGE	CURRENT MATCHING	OUTPUT CURRENT
≥ 0.4 V	±6.0%	5~40 mA
≥ 0.7 V	±6.0%	5~90 mA

PIN CONNECTION (Top view)



TB62705CPG

DIP16-P-300-2.54A

TB62705CFG

SSOP16-P-225-1.00A

TB62705CFNG

SSOP16-P-225-0.65B

Weight

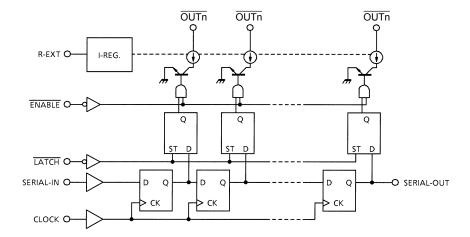
DIP16-P-300-2.54A : 1.11 g (typ.) SSOP16-P-225-1.00A : 0.14 g (typ.) SSOP16-P-225-0.65B : 0.07 g (typ.)

Company Headquarters 3 Northway Lane North Latham, New York 12110 Toll Free: 800.984.5337 Fax: 518.785.4725

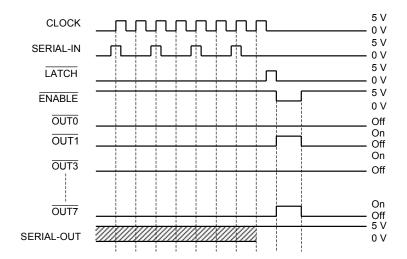




BLOCK DIAGRAM



TIMING DIAGRAM



Note: Latches are level-sensitive, not rising edge-sensitive, and are not synchronized with the CLOCK signal. The data will pass through the latch circuit if the latch input is set at "H" level, and will be retained if the input is set at "L".

PIN DESCRIPTION

PIN No.	PIN NAME	FUNCTION				
1	GND	GND terminal for control logic				
2	SERIAL-IN	Input pin for shift register serial data				
3	CLOCK	Clock input terminal for data shift to up-edge.				
4	LATCH	Data strobe input terminal. Latches pass LATCH data with "H" level input and retain data with "L" level input.				
5~12	OUTn	Output terminals				
13	ENABLE	Input terminal for output enable. All outputs (OUTn) go off with ENABLE data input at "H" level and go on with data input at "L" level.				
14	SERIAL-OUT	Output terminal for serial data for the next SERIAL-IN terminal.				
15	R-EXT	Input terminal for connecting a resistor to regulate all output currents.				
16	V_{DD}	5-V supply pin of the IC				

TRUTH TABLE

CLOCK	LATCH	ENABLE	SERIAL-IN	OUTn	SERIAL-OUT
UP	Н	L	D _n	$D_n \cdots D_{n-5} \cdots D_{n-7}$	D _{n-7}
UP	L	L	D _{n+1}	No change	D _{n-6}
UP	Н	L	D _{n+2}	$D_{n+2} \cdots D_{n-3} \cdots D_{n-5}$	D _{n-5}
DOWN	Х	L	D _{n+3}	$D_{n+2} \cdots D_{n-3} \cdots D_{n-5}$	D _{n-5}
DOWN	Х	Н	D _{n+3}	Off	D _{n-5}

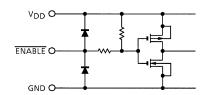
Note: \overline{OUTn} = on if D_n = H level, and \overline{OUTn} = off if D_n = L level.

An external resistor is connected with R-EXT and GND. Be sure to administer the correct power supply voltage.

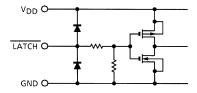
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INPUT/OUTPUT EQUIVALENT CIRCUITS

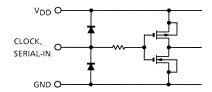
1. ENABLE terminal



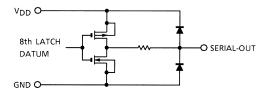
2. LATCH terminal



3. CLOCK, SERIAL-IN terminal



4. SERIAL-OUT terminal





MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Supply Voltage	V_{DD}	0~7.0	V	
Input Voltage	V _{IN}	-0.4~V _{DD} + 0.4	V	
Output Current	lout	90	mA	
Output Voltage	V _{CE}	-0.5~17.0	V	
Clock Frequency	f _{CK} 15		MHz	
GND Terminal Current	I _{GND}	720	mA	
Dougr Discipation	D-	1.47 (CPG-type : FREE AIR, Ta = 25°C)	W	
Power Dissipation	P _D	0.78 (CFG / CFNG-type : ON PCB, Ta = 25°C)	1 vv	
Thermal Resistance	Б	85 (CPG-type : FREE AIR, Ta = 25°C)	°C/W	
Thermal Resistance	R _{th (j−a)}	160 (CFG / CFNG-type : ON PCB, Ta = 25°C)		
Operating Temperature	T _{opr}	-40~85	°C	
Storage Temperature	T _{stg}	-55~150	°C	

Note: CPG type: For an ambient temperature above 25 $^{\circ}$ C, the derating is 11.8 mW/ $^{\circ}$ C.

CFG and CFNG type: For an ambient temperature above 25°C, the derating is 6.3 mW/°C.

RECOMMENDED OPERATING CONDITION (Ta = -40~85°C unless otherwise stated)

CHARACTERISTIC	SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Supply Voltage	V_{DD}	_	4.5	5.0	5.5	V
Output Voltage	V _{OUT}	_	_	_	15.0	V
	IO	OUTn , DC 1 circuit	5	_	88	
Output Current	loh	SERIAL-OUT		_	1.0	mA
	I _{OL}	SERIAL-OUT	_	_	-1.0	
Input Voltage	V _{IH}	_	0.7 V _{DD}	_	V _{DD} +0.3	V
input voitage	V _{IL}	_	-0.3	_	0.3 V _{DD}	
LATCH Pulse Width	t _{w LAT}		100	_	_	ns
CLOCK Pulse Width	t _{w CLK}		50	_	_	ns
ENABLE Pulse Width	t _{w EN}		4500	_	_	ns
Set-up Time for DATA	t _{setup} (D)	V _{DD} = 4.5~5.5 V	60	_	_	ns
Hold Time for DATA	thold (D)		20	_	_	ns
Set-up Time for LATCH	t _{setup (L)}		100	_	_	ns
Hold Time for LATCH	t _{hold (L)}		60	_	_	ns
Clock Frequency	fcK	Cascade operation	10.0	_	_	MHz
Power Dissipation		Ta = 85°C (CPG-type FREE AIR)			0.82	W
i owei Dissipation	P _D	Ta = 85°C (CFG / CFNG-type ON PCB)	_	_	0.40	VV



ELECTRICAL CHARACTERISTICS ($V_{DD} = 5.0 \text{ V}$, Ta = 25°C unless otherwise stated)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	CON	DITION	MIN	TYP.	MAX	UNIT
Input Voltage	"H" Level	V _{IH}	_	_		0.7 V _{DD}	_	V _{DD}	V
input voltage	"L" Level	V _{IL}	_		_		_	0.3 V _{DD}	
Output Leakage Cu	ırrent	loh	_	V _{OH} = 15.0 V		_	_	10	μΑ
Output Voltage	S-OUT	V _{OL}	_	I _{OL} = 1.0 mA		_	_	0.4	V
Output Voltage	3-001	V _{OH}	_	I _{OH} = −1.0 mA		4.6	_	_	\ \ \
Output Current 1		I _{OL1}	_	V _{CE} = 0.7 V	R _{EXT} = 470 Ω	34.1	40.0	45.9	mA
Output Current 1		I _{OL2}	_	V _{CE} = 0.4 V	(Include skew)	33.7	39.5	45.3	IIIA
	Current Skew	Δl _{OL1}	_	I _O = 40 mA, VCE = 0.4 V	R _{EXT} = 470 Ω	_	±1.5	±6.0	%
Output Current 2		I _{OL3}	_	V _{CE} = 1.0 V	R _{EXT} = 250 Ω	64.2	75.5	86.8	mA
Output Current 2		I _{OL4}	_	V _{CE} = 0.7 V	(Include skew)	63.8	75.0	86.2	IIIA
	Current Skew	Δl _{OL2}	_	I _O = 75 mA, V _{CE} = 0.7 V	R _{EXT} = 250 Ω	_	±1.5	±6.0	%
Supply Voltage Reg	gulation	% / V _{DD}	_	R _{EXT} = 470 Ω, Ta = -40~85°C		_	1.5	5.0	% / V
Pull-Up Resistor		R _{IN (up)}	_	_		150	300	600	kΩ
Pull-Down Resisto	Pull-Down Resistor		_	_		100	200	400	kΩ
	"OFF"	I _{DD} (off) 1	_	R _{EXT} = OPEN, OUT0 ~ 7 = off		_	0.6	1.2	
Supply Current		I _{DD (off) 2}	_	$R_{EXT} = 470 \Omega, \overline{OUT0 \sim 7} = off$		3.5	5.8	8.0	
		I _{DD (off) 3}	_	R _{EXT} = 250 Ω,	OUT0 ~ 7 = off	6.5	10.7	15.0	mA
	"ON"	I _{DD (on) 1}	_	R _{EXT} = 470 Ω,	OUT0 ~ 7 = on	7.0	12.0	18.0	
	ON	I _{DD (on) 2}	_	R _{EXT} = 250 Ω,	OUT0 ~ 7 = on	10.0	22.0	32.0	



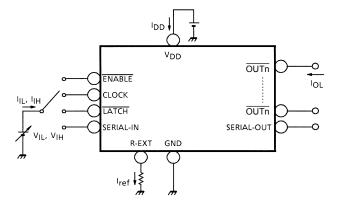
SWITCHING CHARACTERISTICS (Ta = 25°C unless otherwise stated)

CHARACTERISTIC		SYMBOL	TEST CIR- CUIT	CONDITION	MIN	TYP.	MAX	UNIT
	SIN-OUTn				_	1200	1500	- ns
Propagation Delay Time	LATCH - OUTn	.			_	1200	1500	
("L" to "H")	ENABLE - OUTn	t _{pLH}	_		_	1200	1500	
	CLK-SOUT				_	30	70	
	SIN - OUTn				_	700	1000	- ns
Propagation	LATCH - OUTn	4		$V_{DD} = 5.0 \text{ V} \\ V_{CE} = 0.4 \text{ V} \\ V_{IH} = V_{DD} \\ V_{IL} = GND \\ R_{EXT} = 470 \Omega \\ I_{OUT} = 40 \text{ mA} \\ V_{L} = 3.0 \text{ V} \\ R_{L} = 65 \Omega \\ C_{L} = 10.5 \text{ pF} $	_	700	1000	
Delay Time ("H" to "L")	ENABLE - OUTn	t _{pHL}	_		_	700	1000	
	CLK-SOUT				_	30	70	
Pulse Width	СК	t _{w CLK}	_		_	20	30	ns
ruise widiii	LATCH	t _{w LAT}	_		_	10	25	115
Set-up Time	L-H	t _{setup}	_		_	25	50	ns
for LATCH	H-L				_	25	50	1115
Hold Time for	L-H	t _{hold}	_		_	0	30	- ns
LATCH	H-L				_	0	30	
Maximum CLOCK Rise Time		t _r	_		_	_	10	μs
Maximum CLOCK Fall Time		t _f	_		_	_	10	μs
Output Rise Time		t _{or}	_		300	600	1000	ns
Output Fall Time		t _{of}	_		150	300	600	ns

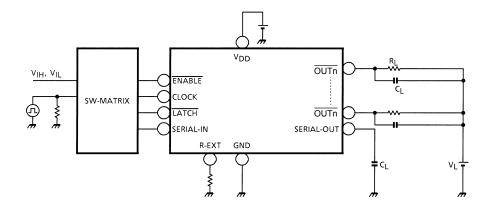


TEST CIRCUIT

DC characteristics



AC characteristics

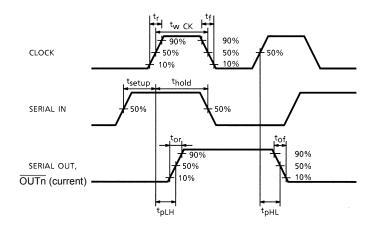


Precaution on Use

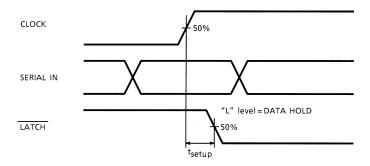
Utmost care is necessary in the design of the output line, V_{CC} (V_{DD}) and GND line since the IC may be damaged due to short-circuits between outputs, air contamination faults, or faults caused by improper grounding.

TIMING WAVEFORM

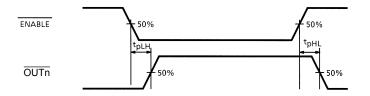
1. CLOCK-SERIAL OUT, OUTn

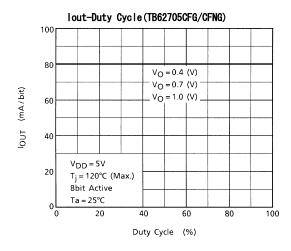


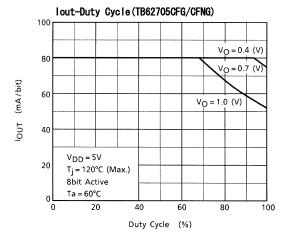
2. CLOCK-LATCH

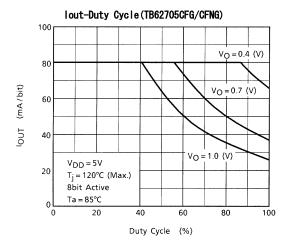


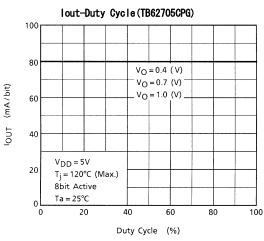
3. ENABLE-OUTn

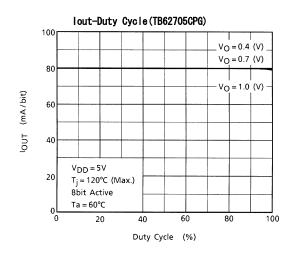


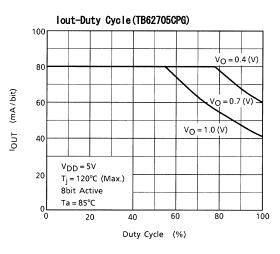




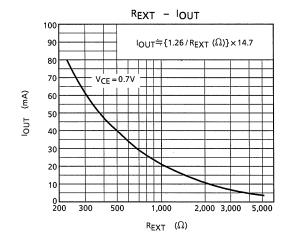


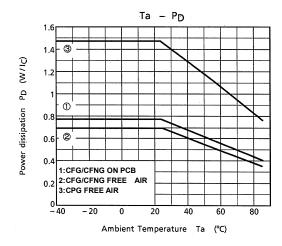






LED DRIVER TB6270X SERIES APPLICATION NOTE







[1] Output current (IOUT)

IOUT is set by the external resistor (R-EXT), as shown in Fig. 1.

[2] Total supply voltage (VLED)

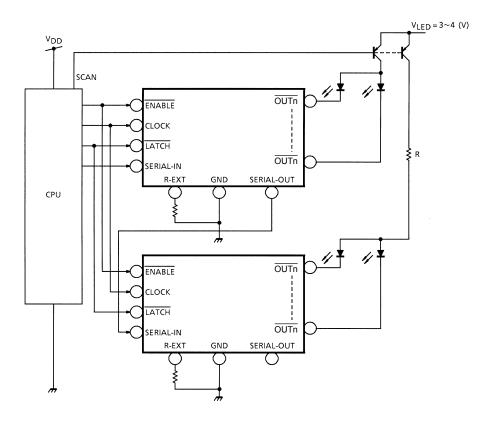
This device can operate on 0.4~0.7 V (VO).

When a higher voltage is input to the device, the excess voltage is consumed inside the device, which leads to power dissipation. To minimize power dissipation and loss, we recommend that the total supply voltage be set as follows:

 $V_{\rm LED}$ (total supply voltage) = $V_{\rm CE}$ (Tr $V_{\rm sat}$) + $V_{\rm f}$ (LED forward voltage) + $V_{\rm O}$ (IC supply voltage).

When the total supply is too high in the light of the power dissipation of this device, an additional resistor (R) can be used to decrease the supply voltage (Vo).

PATTERN LAYOUT



[3] Pattern layout

This device has only one ground pin, i.e., the combined signal ground pin and power ground pin.

If the ground pattern layout contains a large amount of inductance and impedance, and the voltage between the ground and LATCH or CLOCK terminals exceeds 2.5 V due to switching noise, the device may not operate correctly. Be sure to pay attention to pattern layout to minimize inductance.



PACKAGE DIMENSIONS

DIP16-P-300-2.54A

Unit: mm

19.75MAX

19.25±0.2

0.95±0.1

0.735TYP

2.54

1.4±0.1

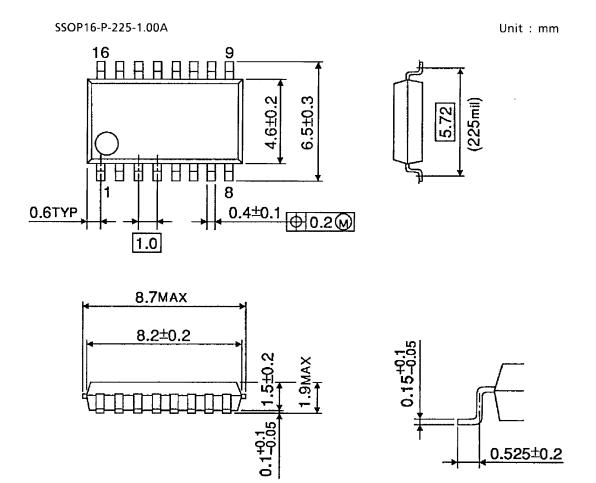
0.5±0.1

0.5±0.1

0.5±0.1

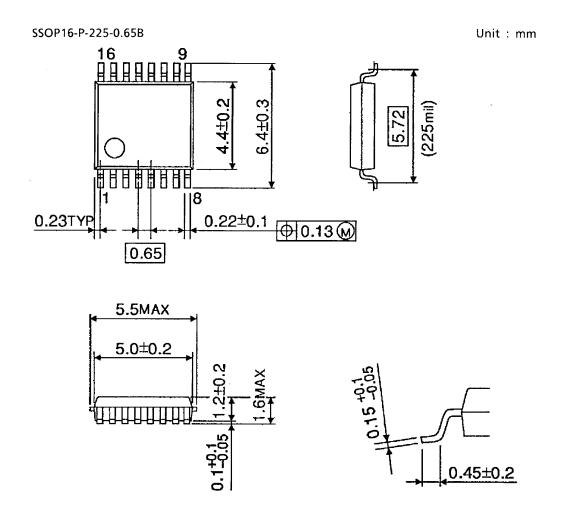
Weight: 1.11 g (Typ.)

PACKAGE DIMENSIONS



Weight: 0.14 g (Typ.)

PACKAGE DIMENSIONS



Weight: 0.07 g (Typ.)

About solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-63Pb solder Bath
 - · solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - · solder bath temperature = 245°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux

RESTRICTIONS ON PRODUCT USE

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